

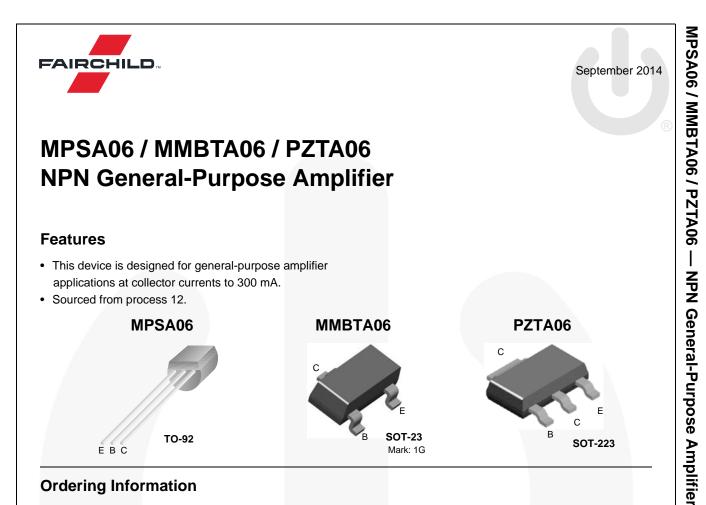
Is Now Part of



# **ON Semiconductor**®

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## **Ordering Information**

Part Number	Top Mark	Package	Packing Method	
MPSA06	MPSA06	TO-92 3L	Bulk	
MMBTA06	1G	SOT-23 3L	Tape and Reel	
PZTA06	A06	SOT-223 4L	Tape and Reel	

## Absolute Maximum Ratings<sup>(1), (2)</sup>

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CEO</sub>	Collector-Emitter Voltage	80	V
V <sub>CBO</sub>	Collector-Base Voltage	80	V
V <sub>EBO</sub>	Emitter-Base Voltage	4.0	V
۱ <sub>C</sub>	I <sub>C</sub> Collector Current - Continuous		mA
T <sub>J,</sub> T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

### Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

## **Thermal Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Max.			Unit
	Falanietei	MPSA06	MMBTA06 <sup>(3)</sup>	PZTA06 <sup>(4)</sup>	Onit
в	Total Device Dissipation	625	350	1000	mW
PD	Derate Above 25°C	5.0	2.8	8.0	mW/°C
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	83.3			°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	200	357	125	°C/W

Notes:

3. Device is mounted on FR-4 PCB 1.6 inch x 1.6 inch x 0.06 inch.

4. Device is mounted on FR-4 PCB 36 mm x 18 mm x 1.5 mm, mounting pad for the collector lead minimum 6 cm<sup>2</sup>.

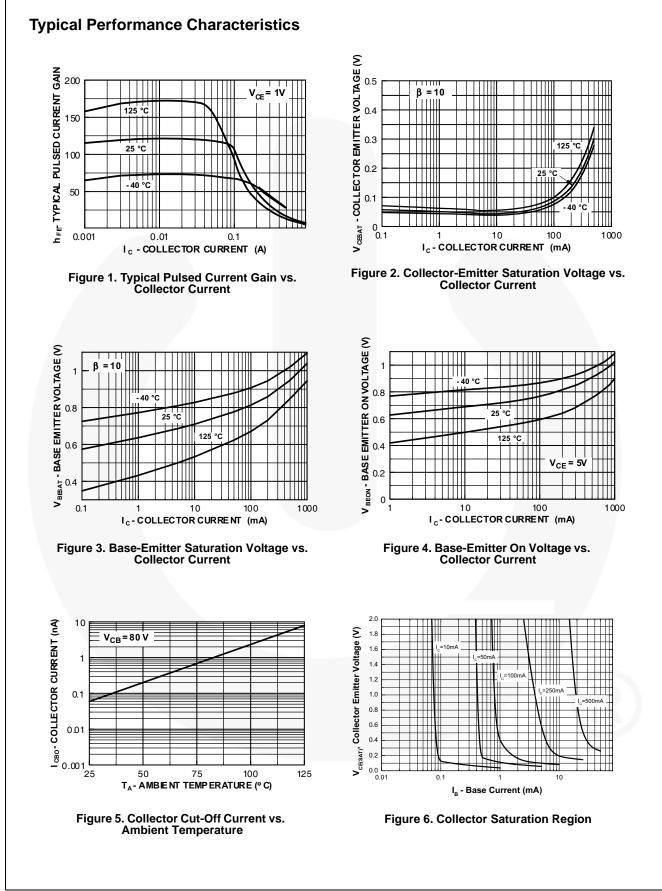
## **Electrical Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

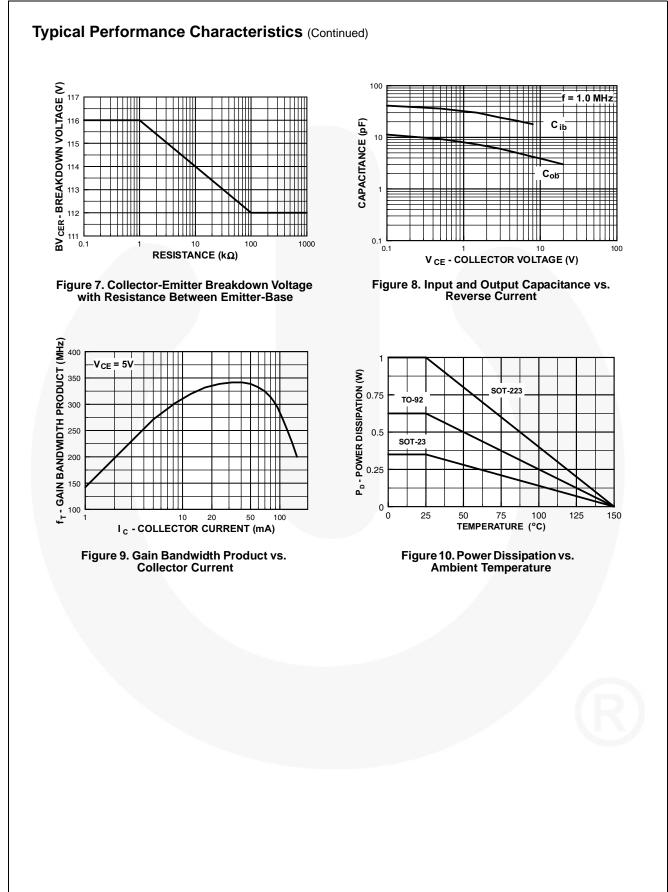
Symbol	Parameter	Conditions	Min.	Max.	Unit
Off Charact	eristics				<u> </u>
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage <sup>(5)</sup>	I <sub>C</sub> = 1.0 mA, I <sub>B</sub> = 0	80		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = 100 μA, I <sub>C</sub> = 0	4.0		V
I <sub>CEO</sub>	Collector Cut-Off Current	$V_{CE} = 60 \text{ V}, \text{ I}_{B} = 0$		0.1	μΑ
I <sub>CBO</sub>	Collector Cut-Off Current	$V_{CB} = 80 \text{ V}, I_{E} = 0$		0.1	μΑ
On Charact	eristics				
h <sub>FE</sub>	DC Current Gain	$I_{C} = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$	100		
		I <sub>C</sub> = 100 mA, V <sub>CE</sub> = 1.0 V	100		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 100 mA, I <sub>B</sub> = 10 mA		0.25	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	I <sub>C</sub> = 100 mA, V <sub>CE</sub> = 1.0 V		1.2	V
Small Signa	al Characteristics			•	
f <sub>T</sub>	Current Gain - Bandwidth Product	$I_{C} = 10 \text{ mA}, V_{CE} = 2.0 \text{ V},$ f = 100 MHz	100		MHz

Notes:

5. Pulse test: pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%.



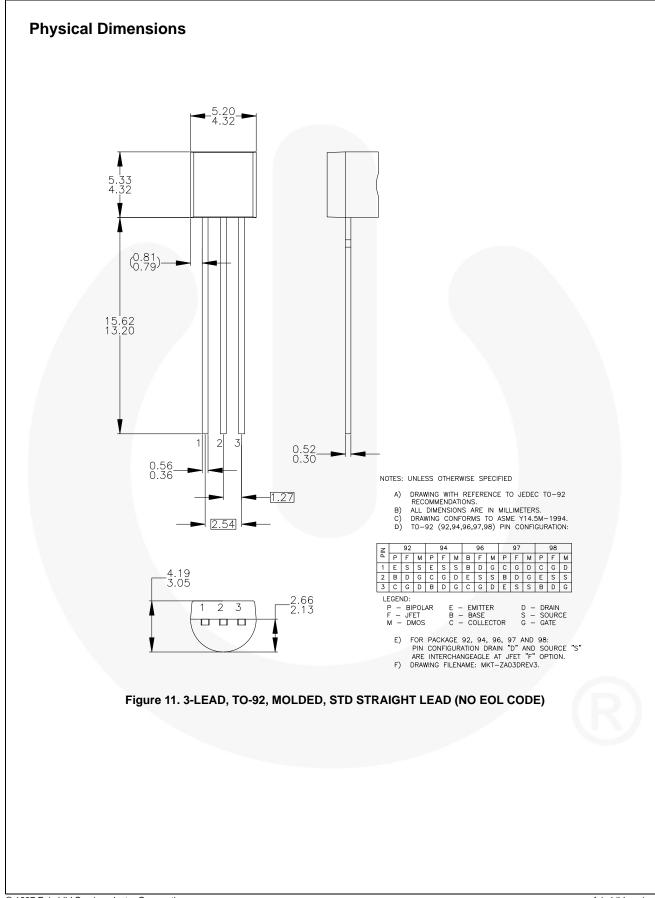
MPSA06 / MMBTA06 / PZTA06 — NPN General-Purpose Amplifier



MPSA06 / MMBTA06 / PZTA06

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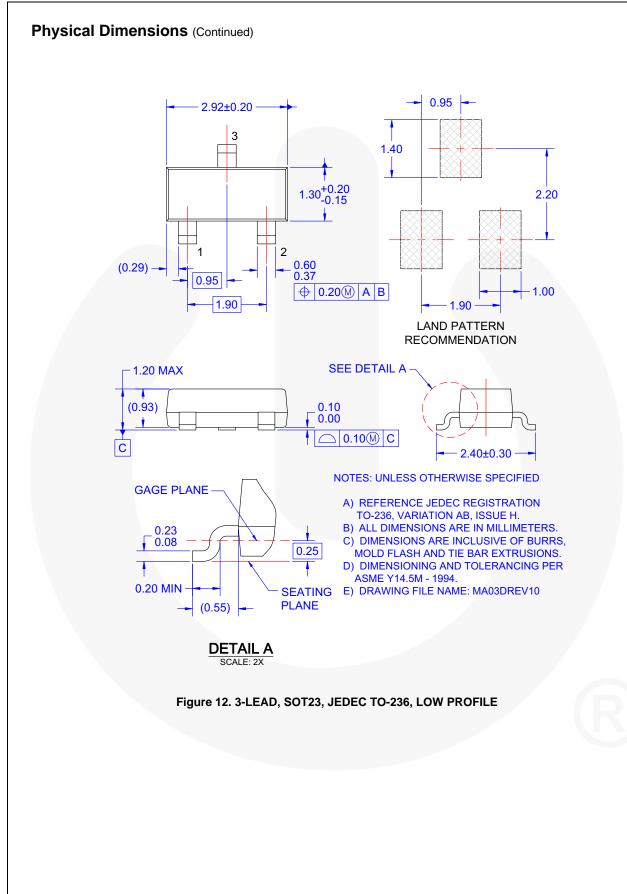
**NPN** General-Purpose Amplifier

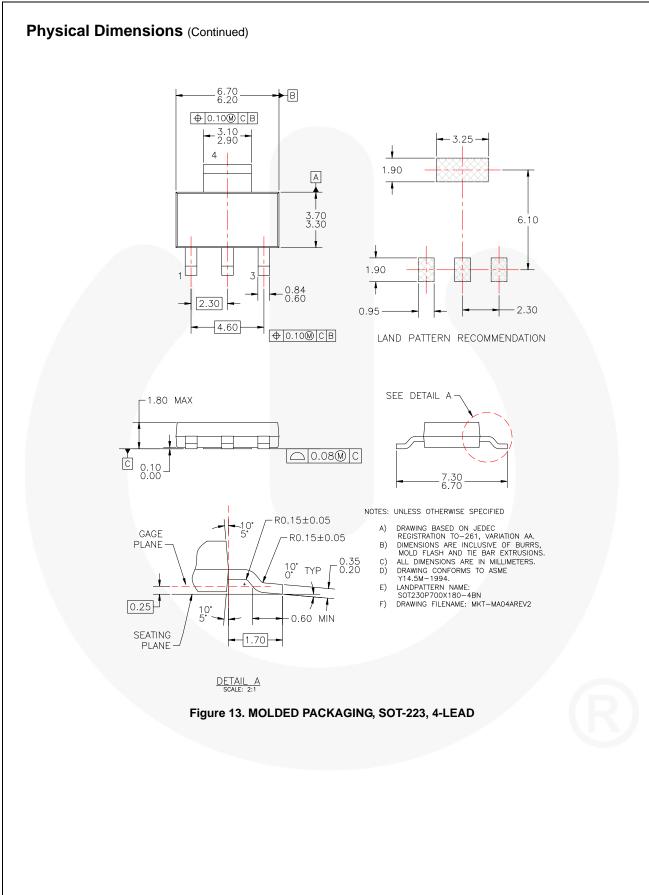


MPSA06 / MMBTA06 / PZTA06

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**NPN General-Purpose Amplifier** 





MPSA06 / MMBTA06 / PZTA06

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**NPN General-Purpose Amplifier** 

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- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
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